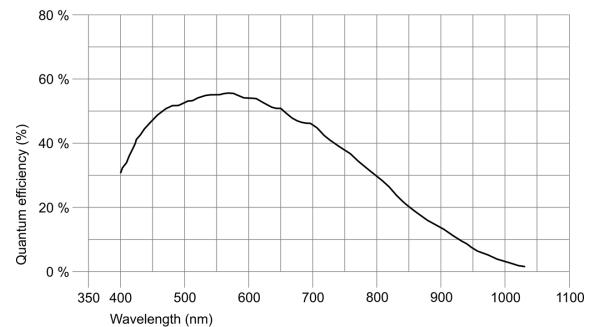




Specification

Sensor

Sensor type	CMOS Mono
Shutter	Rolling shutter
Sensor characteristic	Linear
Readout mode	Progressive scan
Pixel Class	SXGA
Resolution	1.31 Mpix
Resolution (h x v)	1280 x 1024 Pixel
Aspect ratio	5:4
ADC	10 bit
Color depth (camera)	8 bit
Optical sensor class	1/2"
Optical Size	6.656 mm x 5.325 mm
Optical sensor diagonal	8.52 mm (1/1.88")
Pixel size	5.2 µm
Manufacturer	ON Semiconductor
Sensor Model	MT9M001STM
Gain (master/RGB)	13x/-
AOI horizontal	increased frame rate
AOI vertical	increased frame rate
AOI image width / step width	32 / 4
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	-
Binning vertical	-
Binning method	-
Binning factor	-
Subsampling horizontal	increased frame rate
Subsampling vertical	increased frame rate
Subsampling method	Color
Subsampling factor	2, 4, 8



Model

Pixel clock range	5 MHz - 43 MHz
Frame rate freerun mode	25
Frame rate trigger (maximum)	25
Exposure time (minimum - maximum)	0.037 ms - 983 ms
Power consumption	0.5 W - 1 W

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.
For PCB versions, refer to the separate hints in the respective documentation.

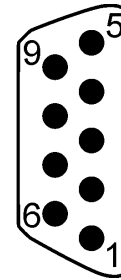
Device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 2.0 mini-B, screwable
I/O connector	9-pin micro D-Sub socket (MPE Garry 11-0021-50-09L)
Power supply	USB cable

Pin assignment I/O connector

1	Flash output with optocoupler (-)
2	Trigger input with optocoupler (+)
3	Shielding
4	USB Power supply (VCC) 5 V
5	USB Ground (GND)
6	Flash output with optocoupler (+)
7	Trigger input with optocoupler (-)
8	USB data (+)
9	USB data (-)



Camera rear view

Design

Lens Mount	-
IP code	-
Dimensions H/W/L	30.0 mm x 30.0 mm x 22.0 mm
Mass	18 g

